

CALL FOR PAPERS

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Submission

Track 1. Signal Processing for Communications

- > Advanced equalization, channel estimation, signal detection, and synchronization techniques
- > Novel architectures for signal demodulation and decoding
- > Signal processing for millimeter and Tera-Hz communication systems
- > Signal processing for single-carrier, OFDM, and NOMA systems
- > Signal processing for MIMO/Massive MIMO systems
- > Machine learning and stochastic geometry-based signal processing

Track 2. Wireless Communications

- > Antennas and propagation
- > MIMO, multi-user MIMO, and massive MIMO
- > OFDM and multi-carrier systems
- > Multiple access techniques and air interfaces (CDMA, TDMA, FDMA, OFDMA, NOMA)
- > Millimeter wave and Terahertz communications
- > Maritime, space, and underwater communications
- > Intelligent reflecting surfaces for wireless communications
- > Ultra-reliable low-latency communication (URLLC)
- > Spectrum sharing and coexistence in heterogeneous networks
- > Privacy and security in wireless communications
- > Visible light communications (VLC) and optical wireless communications (OWC)
- > Wireless charging and energy harvesting
- > Artificial intelligence (AI) and machine learning (ML) for wireless communications

Conference Proceedings

After a peer reviewing process, all accepted papers after proper registration and presentation, will be published in the conference proceedings, and submitted for indexing by **El compendex**.

Submission Method

Scan the QR code or copy the link into your browser to submit your papers: <https://easychair.org/conferences/?conf=apcc2026>

For further information, please visit: <https://apcc2026.org/sub.html>

Track 3. Networking

- > Power System Solutions Towards a Net-Zero Future
- > Beyond 5G/6G and other emerging broadband wireless networks
- > WLAN, WPAN, and other home/personal networking technologies
- > Optical network architecture, design, and control
- > Non-terrestrial networks (NTN)
- > V2X and Vehicular networks
- > Maritime and underwater wireless networks
- > Network function virtualization (NFV) and software-defined networking (SDN)
- > Information-centric networks (ICN) and content centric networks (CCN)
- > Green networks and sustainable communication technologies
- > AI/ML based networks

Track 4. Emerging Technologies, Applications, and Services

- > Context and location-aware wireless services and applications
- > Edge, fog, and cloud computing for emerging applications and services
- > User-centric networks and adaptive services
- > Wireless body area networks and e-health services
- > Intelligent transportation systems
- > Internet of Things (IoT) and smart cities
- > Blockchain and distributed ledger technologies (DLT)
- > Cybersecurity and privacy for communication systems
- > Human-computer interaction (HCI) and user experience (UX)

Important Dates

Submission Deadline June 30, 2026

Notification Deadline July 30, 2026

Camera-ready Due August 30, 2026

Conference Dates November 10-12, 2026

Contact Us

Ms. Cassie Zhan

info@apcc2026.org

+86-135413821022

<https://apcc2026.org>